VPX770

Intel® Ice Lake-D Processor Xeon® D-1746TER with 1/10/40/100GbE and PCIe 3U VPX

Key Features

- Intel® Ice Lake-D Processor Xeon® D-1746TER
- Dual 100/40GbE or octal 10/1GbE on P1
- Additional Dual GbE 1000BASE-KX on P1
- PCIe x16 Gen3 on P2 (bifurcation by quad x4 or dual x8)
- Serial Over LAN (SOL)
- Front panel 10GbE, Display Port (DP), dual USB3.0 and USB2.0 as RS-232 to USB
- 48GB of DDR4 memory with ECC
- M.2 NVMe Storage socket
- Platform Firmware Resilience (PFR) via on board FPGA for security
- Trusted Platform Management (TPM)

Benefits

- Ice Lake-D embedded hardware security features, Al capability, enhanced connectivity and fast boot
- Low power for balanced performance and power
- Ideal upgrade for Broadwell-DE (such as VPX754)
- Electrical, mechanical, software, and system-level expertise in house
- Full system supply from industry leader
- AS9100 and ISO9001 certified company





VPX770

The VPX770 is a Processor VPX (PrVPX) in a 3U VPX form factor based on the Intel® Processor Xeon® D-1746TER (Ice Lake-D) for general purpose processing in demanding embedded applications. The D-1746TER has 10 cores with three channels of DDR4 memory.

The VPX770 comes with 48GB of DDR4 memory with ECC and a M.2 NVMe storage socket. The BIOS allows booting from onboard M.2, PXE, and/or USB.

The Module has dual 100/40GbE or octal 10/1GbE with additional dual GbE on P1. The Module provides PCle x16 Gen3 on P2 which can bifurcate to quad x4 or dual x8.

On the front panel the VPX770 has 2x USB 3.0 type C connectors for extended storage, peripherals, etc., native Display Port (DP), 10GBASE-T as well as three RS-232 ports which connects to the IPMI, BMC and the CPU.

The module utilizes the Intel Bootguard PFR via on board FPGA and Trusted Platform Management (TPM). The FPGA can be reprogrammed by the customer to meet their security beyond what is provided by the PFR.

Linux OS is standard on the VPX770, consult VadaTech for other options.

Block Diagram

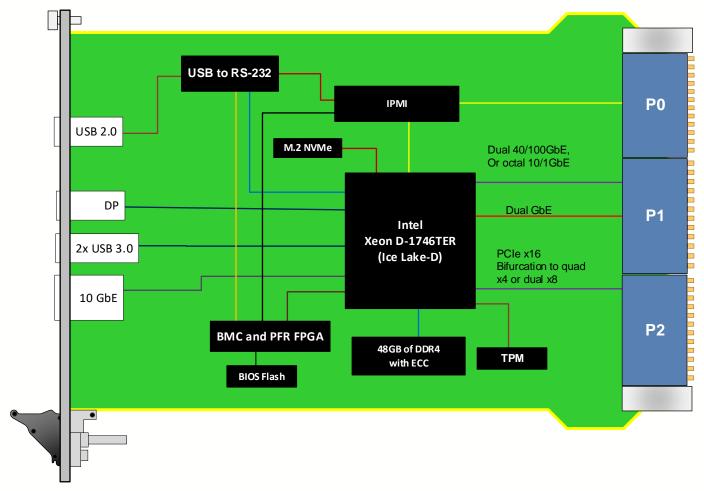
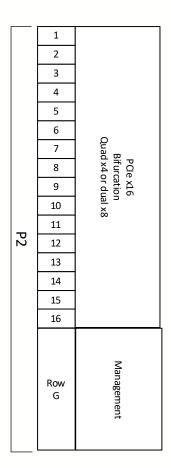


Figure 1: VPX770 Functional Block Diagram

Pinout Block Diagram



	1					
	2					
	3	Dua Oc				
	4	140, 0 tal 1				
	5	/100 or 0/16				
	6	Dual 40/100GbE or Octal 10/1GbE				
P1	7					
	8					
	9					
	10					
	11					
	12					
	13					
	14					
	15	GbE x2				
	16	bE 2				
	Row G	Management				

Figure 2: VPX770 Pinout Block Diagram

Specifications

Architecture					
Physical	Dimensions	3U, 1" Pitch			
Configuration					
Power	VPX770	~75W			
Processor	CPU	Intel® Ice Lake-D Processor Xeon® D-1746TER			
	Memory	DDR4 48GbE with ECC			
	Storage	M.2 NVMe			
	Lanes	Dual 40/100GbE or octal 10/1GbE on P1 and PCle x16 on P2			
VPX Interfaces	Slot Profiles	See Ordering Options			
	Payload Profile	See Figure 2			
	Power Supplies	On P0: +12V and +3.3V_AUX			
Front Panel	Interface Connectors	10GbE-T via RJ-45			
		2x USB 3.0 type C connectors and Display Port (DP)			
		USB2.0 to RS-232 for each sub-system			
	LEDs	IPMI, activity and user defined			
	Mechanical	3U VPX			
Software Support	Operating System	Linux (consult VadaTech for other options)			
Other					
MTBF	MIL Hand book 217-F@ TBD hrs				
Certifications	Designed to meet FCC, CE and UL certifications, where applicable				
Standards	VadaTech is certified to both the ISO9001:2015 and AS9100D standards				
Warranty	Two (2) years, see VadaTech Terms and Conditions				

INTEGRATION SERVICES AND APPLICATION-READY PLATFORMS

VadaTech has a full ecosystem of OpenVPX, ATCA and MTCA products including chassis platforms, shelf managers, AMC modules, Switch and Payload Boards, Rear Transition Modules (RTMs), Power Modules, and more. The company also offers integration services as well as preconfigured Application-Ready Platforms. Please contact VadaTech Sales for more information.

Ordering Options

VPX770 - ABC-DE0-GHJ

A = DDR4 Memory	D = CPU	G = Applicable Slot Profile	
0 = 48GB 1 = Reserved	0 = D-1746TER 1 = Reserved 2 = Reserved	0 = 5HP, VITA 48.1 1 = Reserved	
B = M.2 NVMe Storage	E = M.2 Storage	H = Environmental	
0 = None 1 = 1TB 2 = Reserved	0 = None 1 = 1TB 2 = 2TB 3 = Reserved	See Environmental Specification	
C = VPX Connector Type		J = Conformal Coating	
0 = 50u Gold Rugged High Speed 1 = KVPX		0 = No coating 1 = Humiseal 1A33 Polyurethane 2= Humiseal 1B31 Acrylic 3 = Parylene	

Environmental Specification

Air Cooled			Conduction Cooled		
Option H	H = 0	H = 1	H = 2	H = 3	H = 4
Operating Temperature	AC1* (0°C to +55°C)	AC3* (-40°C to +70°C)	CC1* (0°C to +55°C)	CC3* (-40°C to +70°C)	CC4* (-40°C to +85°C)
Storage Temperature	C1* (-40°C to +85°C)	C3* (-50°C to +100°C)	C1* (-40°C to +85°C)	C3* (-50°C to +100°C)	C3* (-50°C to +100°C)
Operating Vibration	V2* (0.04 g2/Hz max)	V2* (0.04 g2/Hz max)	V3* (0.1 g2/Hz max)	V3* (0.1 g2/Hz max)	V3 (0.1 g2/Hz max)
Storage Vibration	OS1* (20g)	OS1* (20g)	OS2* (40g)	OS2* (40g)	OS2* (40g)
Humidity	95% non-condensing	95% non-condensing	95% non-condensing	95% non-condensing	95% non-condensing

Notes:

^{*}Nomenclature per ANSI/VITA 47. Contact local sales office for conduction cooled (H = 2, 3, 4).

Related Products

VPX516



- 3U FPGA carrier for FPGA Mezzanine Card (FMC) per VITA 46 and VITA 57
- Xilinx Virtex-7 690T FPGA in FFG-1761 package
- High-performance clock jitter cleaner

VPX592



- 3U FPGA carrier for FMC per VITA 46 and VITA 57
- Xilinx Kintex UltraScale™ XCKU115 FPGA
- High-performance clock jitter cleaner

VPX599



- Xilinx Kintex UltraScale™ XCKU115 FPGA
- Dual ADC 12-bit @ 6.4 GSPS
- Dual DAC 16-bit @ 12 GSPS (AD9162 or AD9164)

Contact

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